



Product Change Notification

Change Notification #: 118822-00
Change Title: Select Intel® NUC Rugged Chassis Element CMCR1ABC and Intel® NUC Rugged Board Element CMB1ABC, PCN 118822-00, Product Design, Product Material, Label, Firmware, Label and Box Updates
Date of Publication: January 07, 2022

Key Characteristics of the Change:

Product Design, Product Material, Label

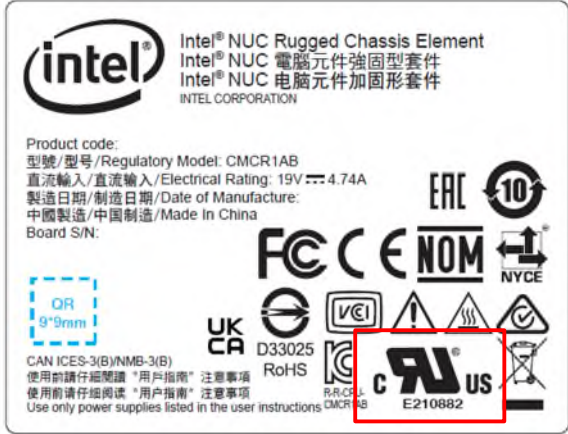
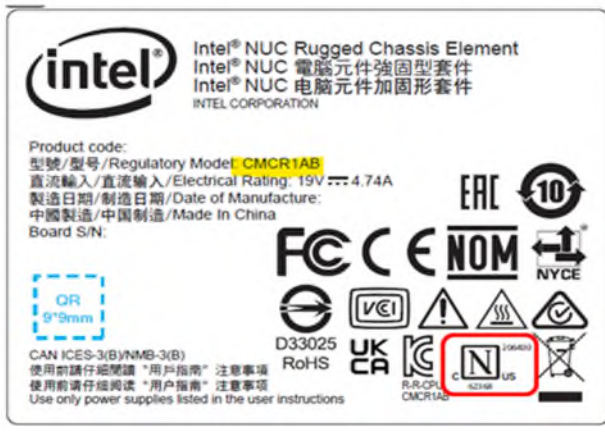
Forecasted Key Milestones:

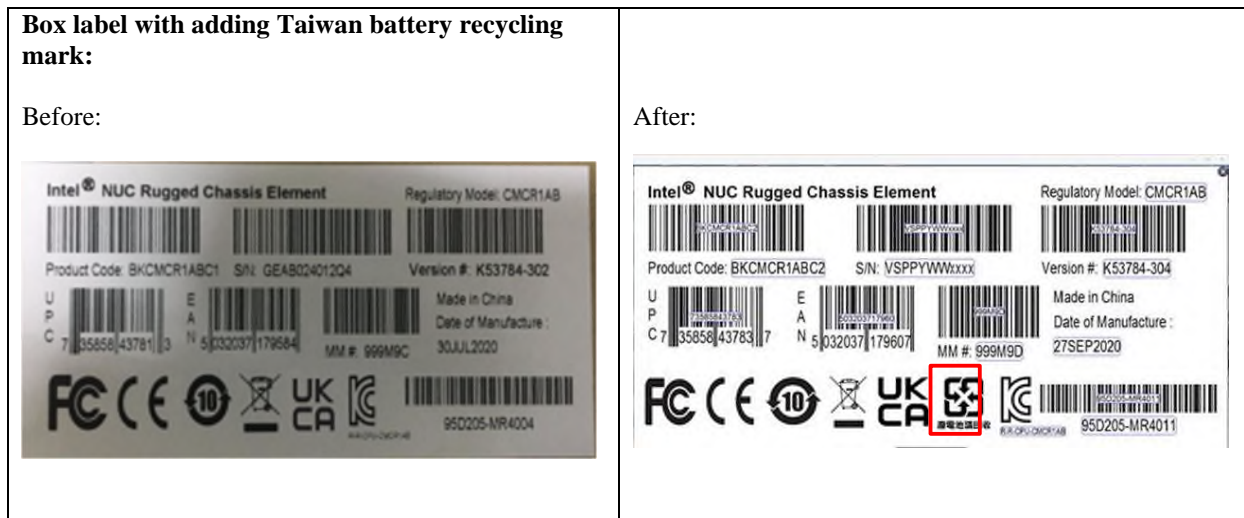
Date Customer Must be Ready to Receive Post-Conversion Material	January 22, 2022
--	------------------

Description of Change to the Customer:

The Intel NUC SKUs listed in the products affected table below will have the following changes:

1. Change CB logo on rating label from UL to NTRL due to Lab convert from UL CB to Nemko NRTL CB
2. Added Taiwan battery recycling mark on box label.
3. Update Embedded Firmware version to 2.23
4. Update HDMI Firmware version to 5.06.001

Change from old part	Change to new part
<p>Rating label with NTRL logo</p> <p>Before:</p>  <p>The image shows the old rating label for Intel NUC Rugged Chassis Element CMCR1AB. It features the Intel logo, product code, regulatory model (CMCR1AB), electrical rating (19V 4.74A), and date of manufacture. The UL logo is highlighted with a red box. Other logos include ENEC, FCC, CE, NOM, NYCE, UK, CA, VCCI, RoHS, and a recycling symbol. The board S/N is E210882.</p>	<p>After:</p>  <p>The image shows the new rating label for Intel NUC Rugged Chassis Element CMCR1AB. It features the Intel logo, product code, regulatory model (CMCR1AB), electrical rating (19V 4.74A), and date of manufacture. The NTRL logo is highlighted with a red box. Other logos include ENEC, FCC, CE, NOM, NYCE, UK, CA, VCCI, RoHS, and a recycling symbol. The board S/N is E210882.</p>



(All pictures are for example only)

Customer Impact of Change and Recommended Action:

These changes have been thoroughly evaluated to ensure that there are no quality or reliability implications to our customers. Milestone dates are estimates and subject to change based on business and operational conditions.

Customer can expect to receive mixed inventory until current inventory levels are depleted.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change SA	Pre Change AA	Post Change SA	Post Change AA
Intel® NUC Rugged Board Element CMB1ABC	BKCMCB1ABC	999M8M		K53779-304		K53779-305
Intel® NUC Rugged Chassis Element CMCR1ABC	BKCMCR1ABC	999M9A	K53784-305		K53784-306	
Intel® NUC Rugged Chassis Element CMCR1ABC	BKCMCR1ABC1	999M9C	K53784-305		K53784-306	
Intel® NUC Rugged Chassis Element CMCR1ABC	BKCMCR1ABC2	999M9D	K53784-305		K53784-306	

PCN Revision History:

Date of Revision:

January 07, 2022

Revision Number:

00

Reason:

Originally Published PCN



Product Change Notification

118822-00

INFORMATION IN THIS DOCUMENT IS PROVIDED IN CONNECTION WITH INTEL PRODUCTS. NO LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE, TO ANY INTELLECTUAL PROPERTY RIGHTS IS GRANTED BY THIS DOCUMENT. EXCEPT AS PROVIDED IN INTEL'S TERMS AND CONDITIONS OF SALE FOR SUCH PRODUCTS, INTEL ASSUMES NO LIABILITY WHATSOEVER AND INTEL DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY, RELATING TO SALE AND/OR USE OF INTEL PRODUCTS INCLUDING LIABILITY OR WARRANTIES RELATING TO FITNESS FOR A PARTICULAR PURPOSE, MERCHANTABILITY, OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

A "Mission Critical Application" is any application in which failure of the Intel Product could result, directly or indirectly, in personal injury or death. SHOULD YOU PURCHASE OR USE INTEL'S PRODUCTS FOR ANY SUCH MISSION CRITICAL APPLICATION, YOU SHALL INDEMNIFY AND HOLD INTEL AND ITS SUBSIDIARIES, SUBCONTRACTORS AND AFFILIATES, AND THE DIRECTORS, OFFICERS, AND EMPLOYEES OF EACH, HARMLESS AGAINST ALL CLAIMS COSTS, DAMAGES, AND EXPENSES AND REASONABLE ATTORNEYS' FEES ARISING OUT OF, DIRECTLY OR INDIRECTLY, ANY CLAIM OF PRODUCT LIABILITY, PERSONAL INJURY, OR DEATH ARISING IN ANY WAY OUT OF SUCH MISSION CRITICAL APPLICATION, WHETHER OR NOT INTEL OR ITS SUBCONTRACTOR WAS NEGLIGENT IN THE DESIGN, MANUFACTURE, OR WARNING OF THE INTEL PRODUCT OR ANY OF ITS PARTS.

Intel may make changes to specifications and product descriptions at any time, without notice. Designers must not rely on the absence or characteristics of any features or instructions marked "reserved" or "undefined". Intel reserves these for future definition and shall have no responsibility whatsoever for conflicts or incompatibilities arising from future changes to them. The information here is subject to change without notice. Do not finalize a design with this information.

The products described in this document may contain design defects or errors known as errata which may cause the product to deviate from published specifications. Current characterized errata are available on request.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

Japan Email: jcb.ijkk@intel.com

Copyright © Intel Corporation 2022. Other names and brands may be claimed as the property of others.

3D XPoint, Axxia, Basis, Basis Peak, BlueMoon, BunnyPeople, Celeron, Centrino, Cilk, Curie, Flexpipe, Intel, the Intel logo, Intel Atom, Intel CoFluent, Intel Core, Intel. Experience What's Inside, the Intel. Experience What's Inside logo, Intel Inside, the Intel Inside logo, Intel Insider, Intel Joule, Intel RealSense, Intel SingleDriver, Intel SpeedStep, Intel Unite, Intel vPro, Intel Xeon Phi, Intel XScale, InTru, the InTru logo, the InTru Inside logo, InTru soundmark, Iris, Itanium, MCS, MMX, Optane, Ostro, Pali, Pentium, picoArray, Picochip, picoXcell, Puma, Quark, SMARTi, Soletta, Sound Mark, StarPro, Stay With It, the Engineering Stay With It logo, StreamSight, Tarari, The Journey Inside, Thunderbolt, the Thunderbolt logo, Transcede, True Key, Ultrabook, VTune, Xeon, X-GOLD, XMM, X-PMU and XPOSYS are trademarks of Intel Corporation or its subsidiaries in the U.S. and/or other countries.

Microsoft, Windows, and the Windows logo are trademarks, or registered trademarks of Microsoft Corporation in the United States and/or other countries. Java is a registered trademark of Oracle and/or its affiliates. Bluetooth is a trademark owned by its proprietor and used by Intel Corporation under license. Intel Corporation uses the Palm OS* Ready mark under license from Palm, Inc. OpenCL and the OpenCL logo are trademarks of Apple Inc. used by permission by Khronos.

Learn how to use Intel Trademarks and Brands correctly at <http://www.intel.com/intel/legal/tmusage2.htm>.